	EAST SEARCH	Date	
L# Hits	Search String	Databases	
L1 170	circuit\$4 and rule\$2 and violation\$2 and (layout near10 view\$6)	US-PGPUB; USPAT; EPO; JPO; DERWENT	7
	1 and (zoom\$5 or magnif\$8)	US-PGPUB; USPAT; EPO; JPO; DERWENT	_
L3 46	5325309.uref.	US-PGPUB; USPAT; EPO; JPO; DERWENT	_
L4 103	circuit\$4 and ((defect\$5 and layout) near10 view\$6)	US-PGPUB; USPAT; EPO; JPO; DERWENT	7
L5 1559	circuit\$4 and (design near10 layout) and view\$6 and (violation\$2 or defect\$2)	US-PGPUB; USPAT; EPO; JPO; DERWENT	_
L6 78	5 and view\$6 near10 (violation\$2 or defect\$2)	US-PGPUB; USPAT; EPO; JPO; DERWENT	_
L7 1	20010020194.PN.	US-PGPUB	
L8 1	6507933.PN.	USPAT; USOCR	
L9 1	6539272.PN.	USPAT; USOCR	
L10 36	5896300	US-PGPUB; USPAT; EPO; JPO; DERWENT	_
	5896300.PN. or "6009252".pn. or "6115546".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT	_
L12 10	6009252.uref.	US-PGPUB; USPAT; EPO; JPO; DERWENT	_
Results of search set L4:	et L4:		<b>.</b>
US 20040169850 A1 US 20040155999 A1	System and method for double sided optical inspection of thin film disks or wafers Liquid crystal display device and electronic apparatus	20040902 356/237.2 20040812 349/114	
	Liquid crystal display unit-use glass substrate and method of producing mother		، د
US 20040134231 A1	glass and mother glass inspection device	65/29.11	le
US 20040121571 A1 US 20040090566 A1	Semiconductor device and a method of manufacturing the same  Thin film transistor array panel	20040624 438/586 20040513 349/43	ab
US 20040086170 A1	Pattern inspecting method and apparatus thereof, and pattern inspecting method on basis of electron beam images and apparatus thereof	20040506	
US 20040080938 A1	Uniform illumination system	362/231	V(
US 20040055793 A1	Electromagnetic inductive system with multi-induction loop layout and battery less pointer device and its method for locating the coordinate	20040325 178/18.01	st A
US 20030229865 A1	Method for eliminating false failures saved by redundant paths during circuit area analysis on an integrated circuit layout	716/4	nC
US 20030205731 A1	Semiconductor integrated circuit device and manufacturing method thereof	257/200	

24 22 28 24 22 28	20040928 20040622 20040224	Inspection method and its apparatus, inspection system  Method of making wiring and logic corrections on a semiconductor device by use of focused ion beams  TFT LCD active data line repair	US 6799130 B2 US 6753253 B1 US 6697037 B1
200	20041026	Method for eliminating false failures saved by redundant paths during circuit area analysis on an integrated circuit layout	US 6810510 B2
8 13	20010913 20010906	Semiconductor integrated circuit device and a method of manufacturing thereof Semiconductor integrated circuit device	US 20010020718 A1 US 20010019499 A1
27	20010927	Semiconductor integrated circuit device and a method of manufacturing thereof	US 20010024859 A1
25 25	20011025 20011025	reproduction method Electric wiring forming system	US 20010033517 A1 US 20010032387 A1
25	20011025	Method of inspecting a pattern and an apparatus thereof and a method of processing a specimen	US 20010033683 A1
97	20020307	Semiconductor device and method for fabricating the same	US 20020028539 A1
3 6	20021010	device using same	US 20020145683 A1
		Electro-optical apparatus having faces holding electro-optical material in between flattened by using concave recess, manufacturing method thereof, and electronic	
17	20021017	Thin film transistor array panel	US 20020149020 A1
4 4	20021114	Computer-aided layout design system with automatic defect-zooming function Semiconductor device	US 20020170028 A1
21	20021121	Semiconductor integrated circuit device and manufacturing method thereof	US 20020173091 A1
8	20030109	Method and its apparatus for inspecting a pattern	20030007677
် ၁	20030306	Electronic parts assembling and testing method, and electronic circuit baseboard manufactured by the method	US 20030042289 A1
3	20030313	Inspection method and its apparatus, inspection system	US 20030050761 A1
င္သ	20030403	Pattern inspection method and system therefor	
င္သ	20030403	Apparatus for inspecting a specimen	US 20030063792 A1
17	20030417	method of manufacturing them	US 20030071309 A1
12	20030612	Thin Film Transistor Array Panel	US 20030107039 A1
22	20031002	device using same	US 20030184705 A1
		Electro-optical apparatus having faces holding electro-optical material in between flattened by using concave recess, manufacturing method thereof, and electronic	
22	20031002	Semiconductor circuit and method of fabricating the same	US 20030186490 A1

	Information storage medium information recording method; and information		•
US 6671243 B2 US 6657231 B2	reproduction method Thin film transistor array panel	20031230 20031202	369/59.1 257/72
US 6614923 B1	Pattern inspecting method and apparatus thereof, and pattern inspecting method on basis of electron beam images and apparatus thereof	20030902	382/149
US 6613500 B1	Reducing resist residue defects in open area on patterned wafer using trim mask	20030902	430/394
US 6611458 B2	Semiconductor integrated circuit device  Electro-optical apparatus having faces holding electro-optical material in between flattened by using concave recess, manufacturing method thereof, and electronic	20030826	365/185.09
US 6611301 B2	device using same	20030826	349/43
6583467	Semiconductor integrated circuit device	20030624	257/316
US 6528378 B2	Semiconductor device	20030304	438/317
US 6519824 B2	Electric wiring forming system	20030218	29/33M
	Electro-optical apparatus having a display section and a peripheral driving circuit		
US 6504215 B1	section	20030107	257/350
US 6302004 BT	Semiconductor device and display device having laser-annealed semiconductor	20021231	011/00/
US 6451636 B1	element	20020917	438/166
US 6444514 B1	Semiconductor integrated circuit device and manufacturing method thereof  Thin film transistor array panel for liquid crystal display and method for repairing	20020903	438/221
US 6441401 B1	the same	20020827	257/72
	Electro-optical apparatus having faces holding electro-optical material in between flattened by using concave recess, manufacturing method thereof, and electronic		
US 6433841 B1	device using same	20020813	349/43
US 6423584 B1	method for forming capacitors and field effect transistors in a semiconductor integrated circuit device	20020723	438/152
US 6420754 B2	Semiconductor integrated circuit device	20020716	257/326
	High speed heterojunction bipolar transistor, and RF power amplifier and mobile		
US 6392258 B1	communication system using the same	20020521	257/197
US 6372558 B1	manufacturing the device and substrate	20020416	438/149
US 6333545 B1	Semiconductor device having blocking layer and fuses	20011225	257/529
US 6330975 B1	Combined code reader and digital camera using a common photodetector Semiconductor memory device having memory cell blocks different in data storage	20011218	235/472.01
US 6236615 B1	capacity without influence on peripheral circuits  Methods of forming nonvolatile integrated circuit memory devices having high	20010522	365/230.03
US 6204122 B1 US 6184947 B1	capacitive coupling ratios Thin film transistor matrix with repairable bus line	20010320 20010206	438/257 349/42

US 5477067 A US 5309246 A	US 5497381 A	US RE35423 E US 5517457 A	US 5615163 A	US 5/12684 A US 5680207 A	US 5736863 A		US 5773857 A	US 5798831 A	US 5801412 A	US 5821523 A	5872386	US 5937290 A	US 5943073 A	US 5947051 A	US 5960256 A	US 5962867 A		US 6020867 A	US 6061281 A	US 6137295 A		US 6150206 A		US 6172513 B1
_	Bitstream defect analysis method for integrated circuits  Semiconductor IC device having a RAM interposed between different logic sections and by-pass signal lines extending over the RAM for mutually connecting		ard solder quality	Viewing apparatus with visual axis detector  Defect inspecting apparatus and defect inspecting method		Abatement of electron beam charging distortion during dimensional measurements of integrated circuit patterns with scanning electron microscopy by the utilization of	Semiconductor device having dummy wiring conductors for suppressing heat-treatment-induced shifting		Semiconductor device having a capacitance element with excellent area efficiency	nera using a common photodetector	of semiconductor device	Method of manufacturing semiconductor integrated circuit devices using phase shifting mask			evice and manufacturing method thereof		Abatement of electron beam charging distortion during dimensional measurements of integrated circuit patterns with scanning electron microscopy by the utilization of	-		nereof	Method and apparatus for use in IDDQ integrated circuit testing		sing trench isolation and	Method for analyzing electrical contact between two conductive members of semiconductor device without destruction thereof
19951219 19940503	19960305	19970 <u>1</u> 14 19960514	19970325	19980127 19971021	19980407		19980630	19980825	19980901	19981013	19990216	19990810	19990824	19990907	19990928	19991005		20000201	20000509	20001024	20001107	20001121		20010109
257/211 358/1.9	714/745	378/58 365/230.03	365/230.03	348/341 356/237.3	324/765		257/211	356/237.2	257/296	235/472.01	257/443	438/238	347/48	114/313	438/14	257/48		345/87	365/200	324/751	324/763	438/238		324/756

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Semiconductor integrated circuit device having a gate array with a ram and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate array  Photomask and fabrication of the same Semiconductor integrated circuit device having a gate array with a RAM and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate array Semiconductor integrated circuit device Method and apparatus for performing automated circuit board solder quality inspections Process and installation for the treatment of rough sheets issuing from a rolling mill for flat products Apparatus for on line, random sample, inspection of cold-formed blanks for threaded fasteners Photoelectrophoretic web imaging apparatus Combination imaging and grounding roller Composite semiconductor unit and method Photoelectrophoretic web machine servo drive system Photoelectrophoretic imaging apparatus having a device for increasing the friction force between webs  Photoelectrophoretic pigment discharging with A.C. corotron or U.V. illumination Electrical defect monitor structure Photoelectrophoretic between tension system Photoelectrophoretic electrostatic tacking capstan web tension system Photoelectrophoretic pigment discharging with A.C. corotron or U.V. illumination Electrical defect monitor structure Photoelectrophoretic pigment discharging with A.C. corotron or U.V. illumination Electrical defect monitor structure Photoelectrophoretic pigment discharging with A.C. corotron or U.V. illumination A.1 Pattern inspection apparatus  Mask defect inspecting method, semiconductor device manufacturing method,		20040617 20040617 20040520		US 20040115541 A1 US 20040113647 A1 US 20040095573 A1
Semiconductor integrated circuit device having a gate array with a ram and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate array  Photomask and fabrication of the same Semiconductor integrated circuit device having a gate array with a RAM and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate array  Semiconductor integrated circuit device Method and apparatus for performing automated circuit board solder quality inspections Process and installation for the treatment of rough sheets issuing from a rolling mill for flat products Apparatus for on line, random sample, inspection of cold-formed blanks for threaded fasteners Photoelectrophoretic web imaging apparatus Composite semiconductor unit and method Photoelectrophoretic concurrent process cycling Photoelectrophoretic web machine servo drive system Photoelectrophoretic pigment discharging with A.C. corotron or U.V. illumination Electrical defect monitor structure Photoelectrophoretic web tension system Photoelectrophoretic web tension system Photoelectrophoretic electrostatic tacking capstan web tension system Photoelectrophoretic electrostatic tacking capstan web tension system		20040708 20040701		US 20040133369 A1 US 20040126003 A1
Semiconductor integrated circuit device having a gate array with a ram and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate array  Photomask and fabrication of the same Semiconductor integrated circuit device having a gate array with a RAM and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate array  Semiconductor integrated circuit device Method and apparatus for performing automated circuit board solder quality inspections Process and installation for the treatment of rough sheets issuing from a rolling mill for flat products Apparatus for on line, random sample, inspection of cold-formed blanks for threaded fasteners Photoelectrophoretic web imaging apparatus Composite semiconductor unit and method Photoelectrophoretic imaging apparatus having a device for increasing the friction force between webs Photoelectrophoretic pigment discharging with A.C. corotron or U.V. illumination 19761112 Photoelectrophoretic web tension system Photoelectrophoretic web tension system Photoelectrophoretic web tension system Photoelectrophoretic web tension system Photoelectrophoretic electrostatic tacking capstan web tension system 19760928 19760928		,	set L6:	Results of search s
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Semiconductor integrated circuit device having a gate array with a ram and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate array  Photomask and fabrication of the same Semiconductor integrated circuit device having a gate array with a RAM and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate array  Semiconductor integrated circuit device Method and apparatus for performing automated circuit board solder quality inspections Process and installation for the treatment of rough sheets issuing from a rolling mill for flat products Apparatus for on line, random sample, inspection of cold-formed blanks for threaded fasteners Photoelectrophoretic web imaging apparatus Combination imaging and grounding roller Composite semiconductor unit and method Photoelectrophoretic web machine servo drive system Photoelectrophoretic imaging apparatus having a device for increasing the friction force between webs  Photoelectrophoretic pigment discharging with A.C. corotron or U.V. illumination 19761102		19760928	Photoelectrophoretic web tension system	US 3983479 A US 3982710 A
Semiconductor integrated circuit device having a gate array with a ram and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate array  Photomask and fabrication of the same Semiconductor integrated circuit device having a gate array with a RAM and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate array  Semiconductor integrated circuit device Method and apparatus for performing automated circuit board solder quality inspections  Process and installation for the treatment of rough sheets issuing from a rolling mill for flat products  Apparatus for on line, random sample, inspection of cold-formed blanks for threaded fasteners  Photoelectrophoretic web imaging apparatus  Combination imaging and grounding roller Composite semiconductor unit and method Photoelectrophoretic web machine servo drive system  Photoelectrophoretic imaging apparatus having a device for increasing the friction 19761116  19761102		19761012	Photoelectrophoretic pigment discharging with A.C. corotron or U.V. illumination	US 3985434 A
Semiconductor integrated circuit device having a gate array with a ram and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate 19930907 5147742 A Photomask and fabrication of the same Semiconductor integrated circuit device having a gate array with a RAM and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate 19920915 Semiconductor integrated circuit device pass signal lines which interconnect a logic section and I/O unit circuit of the gate 19920915 Semiconductor integrated circuit device Method and apparatus for performing automated circuit board solder quality inspections Process and installation for the treatment of rough sheets issuing from a rolling 1980228 Process and installation for the treatment of rough sheets issuing from a rolling 1980204 Apparatus for on line, random sample, inspection of cold-formed blanks for 1980204 Apparatus for on line, random sample, inspection of cold-formed blanks for 1980204 Combination imaging and grounding roller 1970020 Composite semiconductor unit and method 1970206 Photoelectrophoretic web machine servo drive system 1970208		19761102	c imaging apparatus having a device for increasing the fric	US 3989366 A
Semiconductor integrated circuit device having a gate array with a ram and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate 19930907 5147742 A Photomask and fabrication of the same Semiconductor integrated circuit device having a gate array with a RAM and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate 19920407 4959704 A Semiconductor integrated circuit device A809308 A Method and apparatus for performing automated circuit board solder quality 19900925 19900925 A809308 A Process and installation for the treatment of rough sheets issuing from a rolling 19800228 1980228 1980229 1980229 1980228 1980228 1980204 1980		19761116	Photoelectrophoretic web machine servo drive system	
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Semiconductor integrated circuit device having a gate array with a ram and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate  5243208 A array		19770726	Composite semiconductor unit and method	US 4038677 A
Semiconductor integrated circuit device having a gate array with a ram and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate  5243208 A array		19770920	Combination imaging and grounding roller	US 4049343 A
Semiconductor integrated circuit device having a gate array with a ram and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate  5243208 A  array  Photomask and fabrication of the same  Semiconductor integrated circuit device having a gate array with a RAM and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate  5103282 A  4959704 A  Semiconductor integrated circuit device  Method and apparatus for performing automated circuit board solder quality inspections  Process and installation for the treatment of rough sheets issuing from a rolling mill for flat products  Apparatus for on line, random sample, inspection of cold-formed blanks for  19851210  19851210		19780418	Photoelectrophoretic web imaging apparatus	US 4084896 A
Semiconductor integrated circuit device having a gate array with a ram and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate  5243208 A  array  Photomask and fabrication of the same  Semiconductor integrated circuit device having a gate array with a RAM and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate  array  5103282 A  4959704 A  Method and apparatus for performing automated circuit board solder quality inspections  Process and installation for the treatment of rough sheets issuing from a rolling  mill for flat products  Semiconductor integrated circuit device 19920407 1990925 1980228 1980224		19851210	Apparatus tor on line, random sample, inspection of cold-formed blanks for threaded fasteners	4557125
Semiconductor integrated circuit device having a gate array with a ram and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate  19930907  5147742 A Photomask and fabrication of the same Semiconductor integrated circuit device having a gate array with a RAM and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate  19920915  5103282 A array  4959704 A Semiconductor integrated circuit device Semiconductor integrated circuit device  Method and apparatus for performing automated circuit board solder quality  19900925  Method and inspections  Process and installation for the treatment of rough sheets issuing from a rolling		19860204	mill for flat products	US 4569024 A
Semiconductor integrated circuit device having a gate array with a ram and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate 19930907 5147742 A Photomask and fabrication of the same Semiconductor integrated circuit device having a gate array with a RAM and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate 19920915 5103282 A array 4959704 A Semiconductor integrated circuit device Semiconductor integrated circuit device 19920407 19900925 Method and apparatus for performing automated circuit board solder quality		19890228	Inspections  Process and installation for the treatment of rough sheets issuing from a rolling	US 4809308 A
Semiconductor integrated circuit device having a gate array with a ram and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate 19930907 5147742 A Photomask and fabrication of the same Semiconductor integrated circuit device having a gate array with a RAM and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate 19920407 5103282 A Semiconductor integrated circuit device 19920407 19900925			Method and apparatus for performing automated circuit board solder quality	
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Semiconductor integrated circuit device having a gate array with a ram and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate array Photomask and fabrication of the same Semiconductor integrated circuit device having a gate array with a RAM and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate		19920407	аггау	US 5103282 A
Semiconductor integrated circuit device having a gate array with a ram and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate array Photomask and fabrication of the same 19920915			Semiconductor integrated circuit device having a gate array with a RAM and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate	
Semiconductor integrated circuit device having a gate array with a ram and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate array 19930907		19920915	Photomask and fabrication of the same	US 5147742 A
Semiconductor integrated circuit device having a gate array with a ram and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate		19930907	array	US 5243208 A
			Semiconductor integrated circuit device having a gate array with a ram and by- pass signal lines which interconnect a logic section and I/O unit circuit of the gate	<i>,</i>

US 20020170028 A1 US 20020164064 A1 US 20020152453 A1 US 20020144230 A1 US 20020073869 A1 US 20020052053 A1 US 20020035461 A1 US 20020019729 A1	US 20030009736 A1	US 20030054573 A1 US 20030050761 A1 US 20030029345 A1 US 20030022401 A1	US 20030095699 A1	US 20030113009 A1 US 20030097228 A1		US 20030177455 A1	US 20040009416 A1 US 20030212969 A1	US 20040015808 A1	US 20040060018 A1 US 20040057610 A1 US 20040055793 A1	20040086791
Computer-aided layout design system with automatic defect-zooming function System and method of providing mask quality control Photomask and integrated circuit manufactured by automatically correcting design rule violations in a mask layout file System and method for correcting design rule violations in a mask layout file Ultra sensitive magnetic field sensors Inspection system and semiconductor device manufacturing method Visual analysis and verification system using advanced tools VISUAL INSPECTION AND VERIFICATION SYSTEM	Method and apparatus for detail routing using obstacle carving around terminals	Method for manufacturing semiconductor devices and method and its apparatus for processing detected defect data Inspection method and its apparatus, inspection system Ultra sensitive magnetic field sensors  Semiconductor device inspection method	Method for applying a defect finder mark to a backend photomask making process  Tooling frame able to adhere to tin	System and method for confirming electrical connection defects  Apparatus and methods for managing reliability of semiconductor devices	Method for manufacturing semiconductor devices and method and its apparatus for processing detected defect data  User interface for a network-based mask defect printability analysis system	Method and apparatus for interconnect-driven optimization of integrated circuit design	Qualifying patterns, patterning processes, or patterning apparatus in the fabrication of microlithographic patterns  System and method for correcting charge collector violations	System and method for providing defect printability analysis of photolithographic masks with job-based automation	Defect tracking by utilizing real-time counters in network computing environments Mask defect analysis for both horizontal and vertical processing effects Electromagnetic inductive system with multi-induction loop layout and battery less pointer device and its method for locating the coordinate	Photomask defect testing method, photomask manufacturing method and semiconductor integrated circuit manufacturing method
20021114 20021107 20021017 20021003 20020620 20020502 20020502 20020321 20020214	20030109	20030320 20030313 20030213 20030130	20030522	20030619 20030522	20030724 20030703	20030918	20040115 20031113	20040122	20040325 20040325 20040325	20040506
716/11 382/145 716/21 716/19 102/221 438/12 703/13 703/6	716/8	438/4 702/82 102/221 438/14	382/149	382/147 702/82	438/5 716/19	716/2	430/30 716/5	716/19	716/4 382/144 178/18.01	430/5

US 3983479 A	US 4721995 A	US 4755874 A	US 4863275 A	US 4959704 A	US 5103282 A			US 5208782 A	-	US 5243208 A			US 5331458 A	US 5446584 A	US 5477067 A			US 5594800 A	US 5646776 A	US 5771321 A	US 5781446 A	US 5896299 A	US 5933522 A	US 5937290 A		US 6023328 A	US 6185707 B1	00 000000	IIS 6240808 B1	
Electrical defect monitor structure	Integrated circuit semiconductor device formed on a wafer	Emission microscopy system	Portable, shock-proof container surface profiling instrumentation	Semiconductor integrated circuit device	аггау	pass signal lines which interconnect a logic section and I/O unit circuit of the gate	Semiconductor integrated circuit device having a gate array with a RAM and by-	lead on chip (LOC) arrangement	Semiconductor integrated circuit device having a plurality of memory blocks and a	аггау	pass signal lines which interconnect a logic section and I/O unit circuit of the gate	Semiconductor integrated circuit device having a gate array with a ram and by-	Compact specimen inspection station	Compact specimen processing station	the logic sections	sections and by-pass signal lines extending over the RAM for mutually connecting	Semiconductor IC device having a RAM interposed between different logic	Sound reproduction system having a matrix converter	Compact specimen inspection station	Micromechanical optical switch and flat panel display	System and method for multi-constraint domain electronic system design mapping	Method and a system for fixing hold time violations in hierarchical designs	Specific part searching method and device for memory LSI	shifting mask	Method of manufacturing semiconductor integrated circuit devices using phase	Photomask inspection method and apparatus	circuits to physical representation	In that software system for manning logical functional test data of logic integrated	Method and system for reliability analysis of CMOS VLSI circuits based on stage	
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	March 199	97	•	<b>J</b> ,
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### 4 A new approach to scan chain reordering using physical design information

Hirech, M.; Beausang, J.; Xinli Gu;

Test Conference, 1998. Proceedings. International, 18-23 Oct. 1998

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# 5 Three-dimensional defect sensitivity modeling for open circuits in ULSI structures

Kidambi, M.K.; Tyagi, A.; Madani, M.R.; Bayoumi, M.A.;

Computer-Aided Design of Integrated Circuits and Systems, IEEE Transactions

on, Volume: 17 Issue: 4, April 1998

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### 6 Yield estimation of VLSI circuits with downscaled layouts

Pleskacz, W.A.;

Defect and Fault Tolerance in VLSI Systems, 1999. DFT '99. International

Symposium on , 1-3 Nov. 1999

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# 7 SmartBit<sup>TM</sup>: bitmap to defect correlation software for yield improvement

Merino, M.A.; Cruceta, S.; Garcia, A.; Recio, M.;

Advanced Semiconductor Manufacturing Conference and Workshop, 2000

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### 8 An optimal replacement policy for cooling of 3D stacked mesh array

Inoguchi, Y.; Matsuzawa, T.; Horiguchi, S.;

High Performance Computing in the Asia-Pacific Region, 2000. Proceedings. The Fourth International Conference/Exhibition on , Volume: 2 , 14-17 May 2000

Page(s): 1087 -1096 vol.2

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#### 9 A 3-step approach for performance-driven whole-chip routing

Yih-Chih Chou; Youn-Long Lin;

Design Automation Conference, 2001. Proceedings of the ASP-DAC 2001. Asia

and South Pacific , 30 Jan.-2 Feb. 2001

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1 RISCE—a reduced instruction set circuit extractor for hierarchical VLSI layout verification

Volker Henkel, Ulrich Golze

June 1988 Proceedings of the 25th ACM/IEEE conference on Design automation

Full text available: pdf(1.00 MB)

Additional Information: full citation, abstract, references, citings, index terms

We present a circuit extractor preserving the hierarchical layout structure isomorphically. As opposed to existing extractors, our approach permits all cell overlaps which are electrically meaningful. New mask operations based on stretched geometries handle topologically open and closed areas. A reduced set of model independent instructions is introduced for device recognition. An existing implementation is discussed.

2 An enhanced flow model for constraint handling in hierarchical multi-view design environments



Pieter van der Wolf, Olav ten Bosch, Alfred van der Hoeven

November 1994 Proceedings of the 1994 IEEE/ACM international conference on Computer-aided design

Full text available: pdf(958.27 Additional Information: full citation, abstract, references, citings, index terms

In this paper we present an enhanced design flow model that increases the capabilities of a CAD framework to support design activities on hierarchical multi-view design descriptions. This flow model offers new constructs for the configuration of complex design constraints in terms of conditions on the hierarchical multi-view structure of a design. The design flow management system enforces these constraints and uses them to inform the designer more effectively about the validity of verifica ...

3 Session 6A: placement II: Effective partition-driven placement with simultaneous level processing and global net views



Ke Zhong, Shantanu Dutt

November 2000 Proceedings of the 2000 IEEE/ACM international conference on Computer-aided design

Full text available: pdf(113.97

Additional Information: full citation, abstract, references, citings

In this paper we take a fresh look at the partition-driven placement (PDP) paradigm for standard-cell placement for wire-length minimization. The goal is to develop several new algorithms for incorporation into a PDP framework that can rectify the well-known drawbacks of traditional PDP (increasingly localized view of nets with increasing levels of the partitioning tree, min-cut objective, inaccuracy and cost of terminal propagation (TP), irreversibility of move decisions), while preserving its ...

Automatic layout synthesis of leaf cells

Sanjay Rekhi, J. Donald Trotter, Daniel H. Linder

January 1995 Proceedings of the 32nd ACM/IEEE conference on Design automation

Full text available: pdf(154.40 KB)

Additional Information: full citation, references, citings, index terms

5 Highlights of CMU research on CAD, CAM and CAT of VLSI circuits John Paul Shen

November 1999 Proceedings of 1986 ACM Fall joint computer conference

Full text available: pdf(1.35 MB) Additional Information: full citation, references, index terms

Technology retargeting for IC layout

John Lakos

June 1997 Proceedings of the 34th annual conference on Design automation -Volume 00

Full text available: pdf(87.81 KB) Additional Information: full citation, abstract, references, index Publisher Site terms

The ability to recognize polygon-based layout as a collection of objects representing circuit elements connected by path-based wires, enables existing designs implemented using an older fabrication process to be reimplanted quickly in a new process. The approachtaken here, based on layout generator technology, is to create acollection of parameterized circuit objects that, with appropriate arguments, are able to represent the devices (e.g., transistors, contacts) implicitly described in the flattened ...

7 Placement of variable size circuits on LSI masterslices

K. H. Khokhani, A. M. Patel, W. Ferguson, J. Sessa, D. Hatton June 1981 Proceedings of the 18th conference on Design automation

KB)

Full text available: pdf(671.53 Additional Information: full citation, abstract, references, citings, index terms

2 of 6

With the advent of large scale integration (LSI and VLSI), logic circuit densities per chip have grown to hundreds and thousands. The arrangement of interconnected logic circuits of different sizes and shapes poses a difficult combinatorial placement problem. In this paper, an overview of techniques is presented for placing different size rectangular circuits with limited locations on the chip, considering the function of level sensitive scan design (LSSD)1, as well as ...

8 Hierarchical Current Density Verification for Electromigration Analysis in Arbitrary Shaped Metallization Patterns of Analog Circuits



G. Jerke, J. Lienia

March 2002 Proceedings of the conference on Design, automation and test in **Europe** 

Full text available: R pdf(367.21



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Electromigration is caused by high current density stressin metallization patterns and is a major source of break-down in electronic devices. It is therefore an importantreliability issue to verify current densities within allstressed metallization patterns. In this paper we propose anew methodology for hierarchical verification of currentdensities in arbitrarily shaped analog circuit layouts, including a quasi-3D model to verify irregularities suchas vias. Our approach incorporates thermal simul

A 2-dimensional placement algorithm for the layout of electrical circuits. Daniel G. Schweikert



June 1976 Proceedings of the 13th conference on Design automation

Full text available: Ddf(803.45

Additional Information: full citation, abstract, references, citings,

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PLAC is a multi-algorithm, 2-dimensional placement program which accommodates many of the "real world" constraints which occur in the layout of electrical circuits. PLAC was implemented as part of LTX [1], a general integrated circuit layout system, but is capable of handling circuit layout tasks from other technologies (e.g., PC boards, ceramic substrates). PLAC interlaces constructive initial placement with iterative pairwise exchange, using an approximation of tota ...

10 A 2-dimensional placement algorithm for the layout of electrical circuits



D. G. Schweikert

June 1988 Papers on Twenty-five years of electronic design automation

Full text available: pdf(960.80

Additional Information: full citation, references, index terms

11 Cellular image processing techniques for VLSI circuit layout validation and routing



T. N. Mudge, R. A. Rutenbar, R. M. Lougheed, D. E. Atkins

January 1982 Proceedings of the 19th conference on Design automation

KB)

Full text available: pdf(769.83

Additional Information: full citation, abstract, references, citings,

index terms

The architecture of the Cytocomputer?, an existing special-purpose, pipelined cellular image processor, is described. A formalism used to express cellular operations on images is then given. Cellular image processing algorithms are then developed that perform (1) design rule checks (DRC's) on VLSI circuit layouts, and (2) Lee-type wire routing. Two sets of cellular image processing transformations for checking the Mead and Conway design rules and for Lee-routing have been defined and used t ...

### 12 Automatic VLSI layout verification

Laurin Williams

June 1981 Proceedings of the 18th conference on Design automation

Full text available: 🔁 pdf(468.70 Additional Information: full citation, abstract, references, citings, KB) index terms

Xerox has instituted a set of software tools that close the loop between circuit design and mask generation of VLSI and provide checks and analysis along the way. The software includes circuit extraction, capacitance calaulation, nodal analysis and logic recognition as well as interfaces to graphic systems. The systematic method of capturing circuit designs and the software packages for analyzing mask data are described in this paper. The kinds of errors checked and the method of reporting ...

### 13 Magic: A VLSI layout system

John K. Ousterhout, Gordon T. Hamachi, Robert N. Mayo, Walter S. Scott, George S.

June 1984 Proceedings of the 21st conference on Design automation

Full text available: pdf(825.95 Additional Information: full citation, abstract, references, citings, KB) index terms

Magic is a "smart" layout system for integrated circuits. The user interface is based on a new design style called logs, which combines the efficiency of mask-level design with the flexibility of symbolic design. The system incorporates expertise about design rules and connectivity directly into the layout system in order to implement powerful new operations, including: a continuous design-rule checker that operates in background to maintain an up-to-date pictur ...

### 14 The Compilation of Regular Expressions into Integrated Circuits

Robert W. Floyd, Jeffrey D. Ullman

July 1982 Journal of the ACM (JACM), Volume 29 Issue 3

Full text available: pdf(983.18 Additional Information: full citation, references, citings, index terms KB)

### 15 A data path layout assembler for high performance DSP circuits

H. Cai, S. Note, P. Six, H. De Man

January 1991 Proceedings of the 27th ACM/IEEE conference on Design automation

Full text available: pdf(767.84 Additional Information: full citation, abstract, references, citings, index terms

A system is presented which automatically generates layout of bit-sliced data paths in high performance DSP circuits. The system consists of a linear placement tool, a track assignment tool and detailed layout tools. In this paper we will present algorithms for linear placement of modules and routing track assignment across the modules. By taking advantage of the inherent structure of the circuits an A\* based linear placement algorithm has produced better results compar ...

### 16 The role of timing verification in layout synthesis

Jacques Benkoski, Andrzej J. Strojwas

June 1991 Proceedings of the 28th conference on ACM/IEEE design automation

Full text available: pdf(889.07

Additional Information: full citation, references, citings, index terms

### 17 Fabric-driven logic synthesis: River PLAs: a regular circuit structure

Fan Mo, Robert K. Brayton

June 2002 Proceedings of the 39th conference on Design automation

Full text available: pdf(297.44

Additional Information: full citation, abstract, references, citings, index terms

A regular circuit structure called a River PLA and its re-configurable version, Glacier PLA, are presented. River PLAs provide greater regularity than circuits implemented with standard-cells. Conventional optimization stages such as technology mapping, placement and routing are eliminated. These two features make the River PLA a highly predictable structure. Glacier PLAs can be an alternative to FPGAs, but with a simpler and more efficient design methodology.

**Keywords**: programmable logic array, river routing

### 18 The evolution of design automation to meet the challanges of VLSI

Lawrence M. Rosenberg

June 1980 Proceedings of the 17th conference on Design automation

Full text available: pdf(997.27 KB)

Additional Information: full citation, abstract, references, citings, index terms

This paper presents the author's opinion of the major problems confronting Design Automation for VLSI and how Design Automation may evolve to meet these challenges. The paper first takes a historical look at the driving forces for Design Automation development by analyzing the evolution of Design Automation at RCA. It looks at both some successful and unsuccessful development efforts and attempts to isolate some of the criteria necessary for success. It review RCA's current LSI Design Autom ...

# 19 A "non-restrictive" artwork verification program for printed circuit boards

David Kaplan

January 1982 Proceedings of the 19th conference on Design automation

Full text available: pdf(639.01

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Additional Information: full citation, abstract, references, index terms





This paper describes a PCB artwork verification program which imposes virtually no restrictions on the layout designer. The program is capable of making fast and reliable verifications of layouts of any type and style. The concepts and techniques used to achieve the "non-restrictive" feature of the program are discussed. A unique characteristic of the program is the special treatment of nonelectrical elements. The program has been proven by continuous practical use in a dynamic ...

20 Session 8C: advances in layout and synthesis: Layout-driven area-constrained timing optimization by net buffering



Rajeev Murgai

November 2000 Proceedings of the 2000 IEEE/ACM international conference on Computer-aided design

Full text available: pdf(252.73 KB)

Additional Information: full citation, abstract, references

With the advent of deep sub-micron technologies, interconnect loads and delays are becoming significant, and layout-driven synthesis has become the need of the day. However, given the tight constraints imposed by the layout (e.g., area availability, congestion), only those synthesis transforms can be made layout-driven that are local and layout-friendly. Examples of such transforms are net buffering, gate resizing, and gate replication. In this paper, we address the problem of minimizing the dela ...

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Douglas Holt and Michael J Berens, Tribune staff reporters. Chicago Tribune. Chicago, Ill.: Apr 29, 2001. p. 1

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